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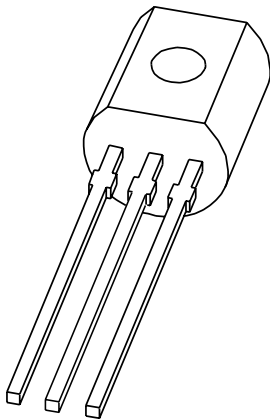
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DATA SHEET



BC368

**NPN medium power transistor;
20 V, 1 A**

Product data sheet
Supersedes data of 2003 Dec 01

2004 Nov 05

NPN medium power transistor; 20 V, 1 A

BC368

FEATURES

- High current.

APPLICATIONS

- Linear voltage regulators
- Low side switch
- Supply line switch for negative voltages
- MOSFET driver
- Audio (pre-) amplifier.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|-----------|---------------------------|------|------|------|
| V_{CEO} | collector-emitter voltage | – | 20 | V |
| I_C | collector current (DC) | – | 1 | A |
| I_{CM} | peak collector current | – | 2 | A |
| h_{FE} | DC current gain | 85 | 375 | – |

DESCRIPTION

NPN medium power transistor (see “Simplified outline, symbol and pinning” for package details).

PRODUCT OVERVIEW

| TYPE NUMBER | PACKAGE | | MARKING CODE | PNP COMPLEMENT |
|-------------|---------|--------|--------------|----------------|
| | PHILIPS | EIAJ | | |
| BC368 | SOT54 | SC-43A | C368 | BC369 |

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

| TYPE NUMBER | SIMPLIFIED OUTLINE AND SYMBOL | PINNING | |
|-------------|-------------------------------|-------------|------------------------------|
| | | PIN | DESCRIPTION |
| BC368 | | 1 2 3 | base collector emitter |

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|-------------|---------|--|---------|
| | NAME | DESCRIPTION | VERSION |
| BC368 | SC-43A | plastic single-ended (through hole) package; 3 leads | SOT54 |

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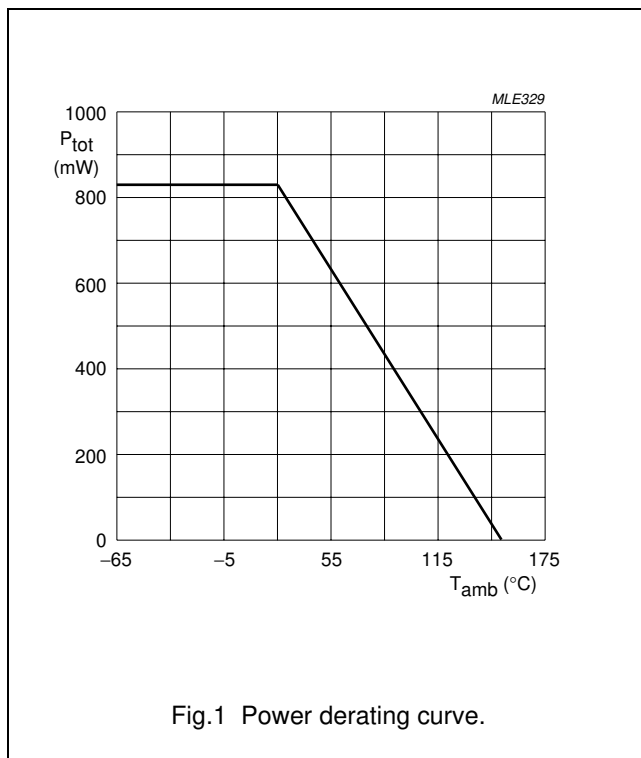
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|---------------------------|---|------|------|------|
| V _{CB0} | collector-base voltage | open emitter | – | 32 | V |
| V _{CEO} | collector-emitter voltage | open base | – | 20 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 5 | V |
| I _C | output current (DC) | | – | 1 | mA |
| I _{CM} | peak collector current | | – | 2 | mA |
| I _{BM} | peak collector current | | – | 200 | mA |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C; notes 1 and 2 | – | 0.83 | W |
| T _{stg} | storage temperature | | –65 | +150 | °C |
| T _j | junction temperature | | – | 150 | °C |
| T _{amb} | ambient temperature | | –65 | +150 | °C |

Notes

1. Refer to SOT54 (SC-43A) standard mounting conditions.
2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.



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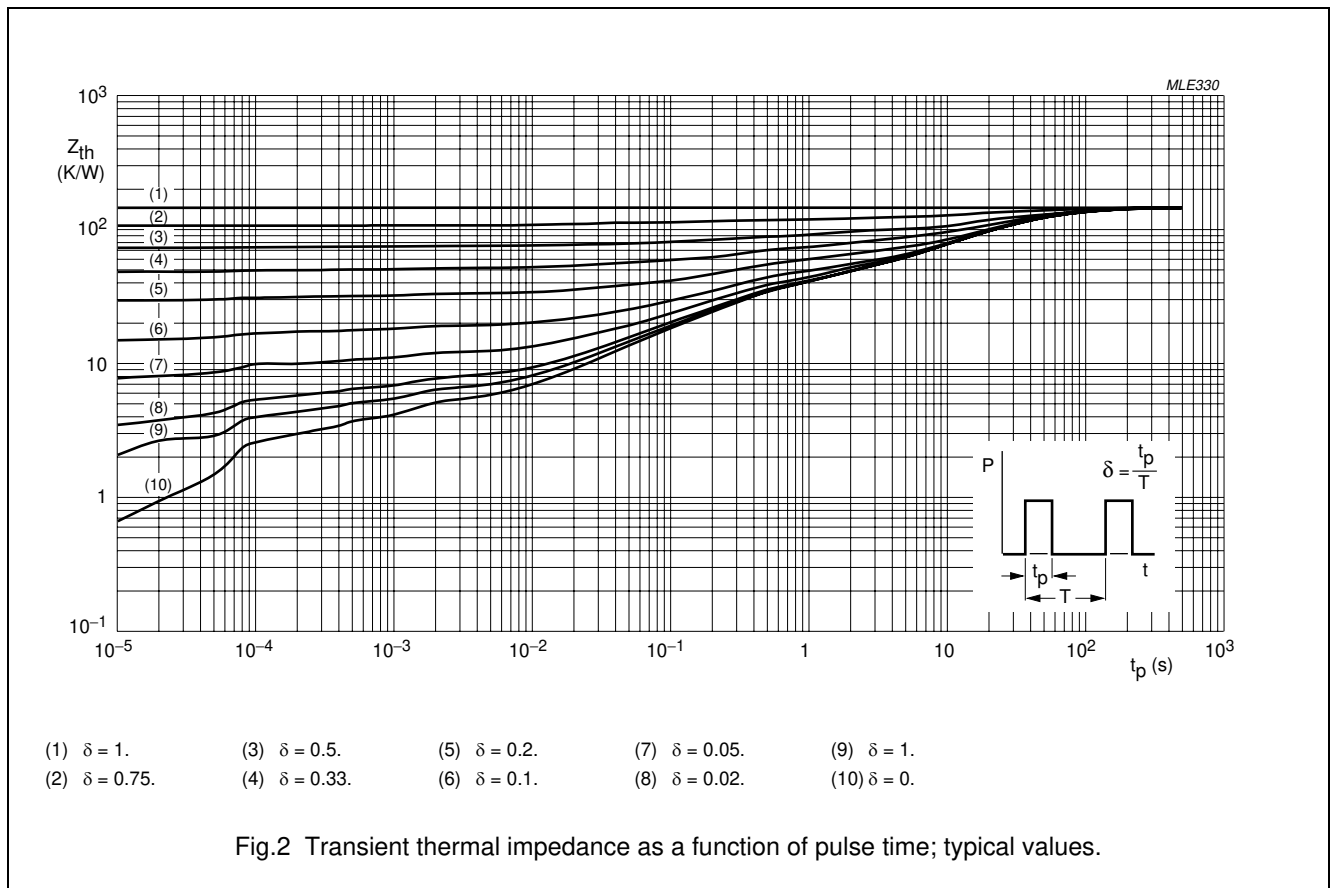
BC368

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|---|-------|------|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | $T_{amb} \leq 25\text{ }^\circ\text{C}$; notes 1 and 2 | 150 | K/W |

Notes

1. Refer to SOT54 (SC-43A) standard mounting conditions.
2. Device mounted on an FR4 printed-circuit board, single-sided copper, tin-plated footprint.



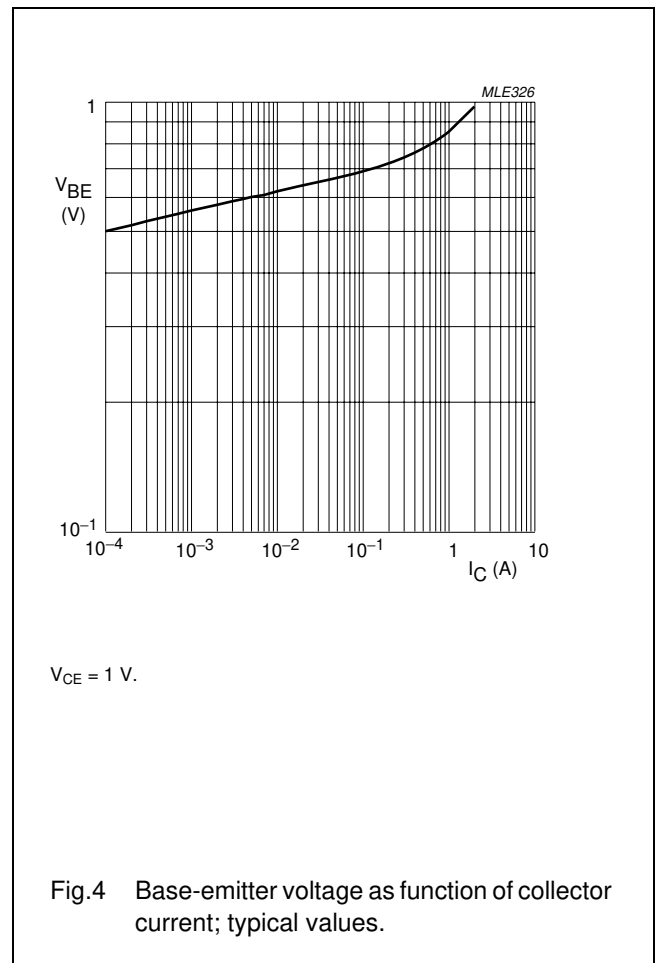
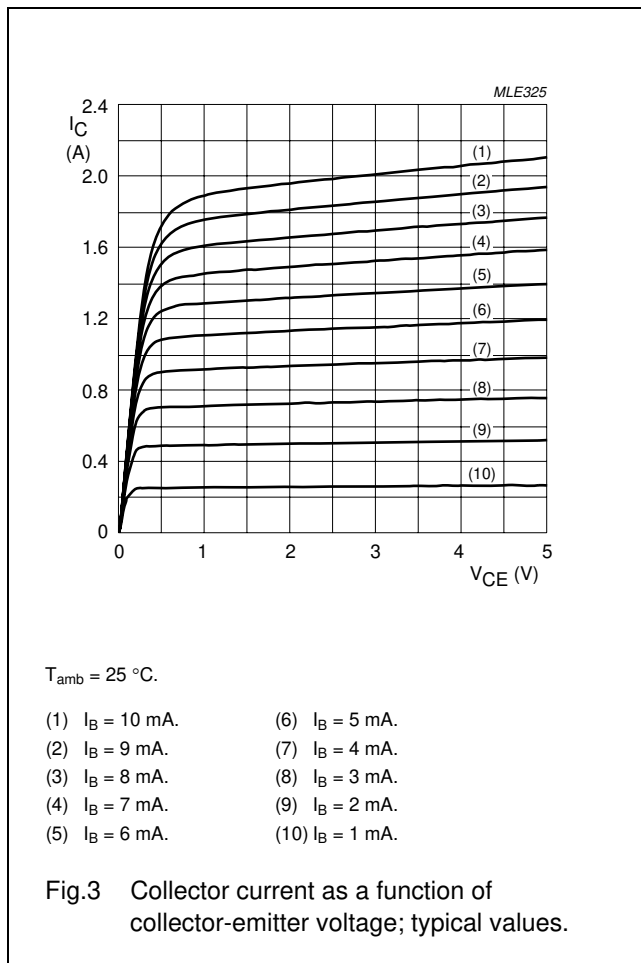
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CHARACTERISTICS

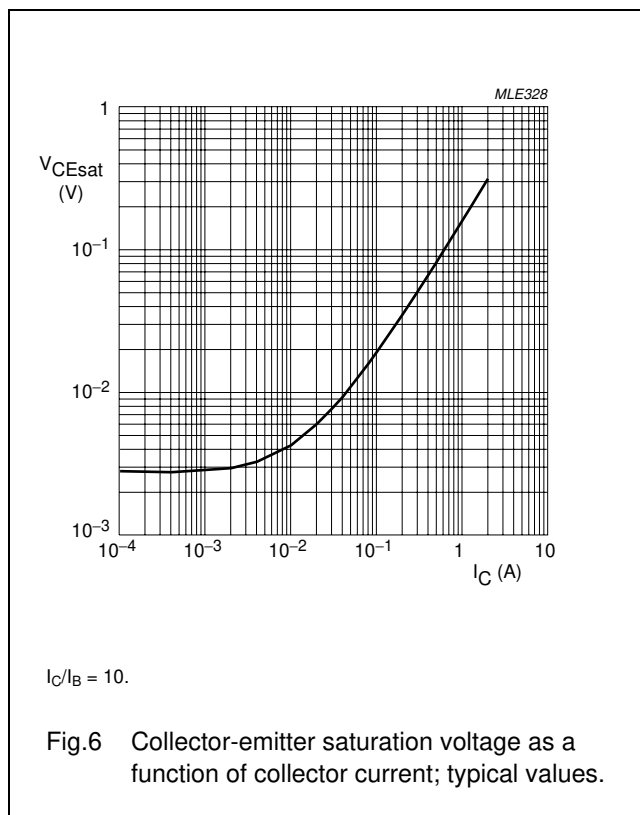
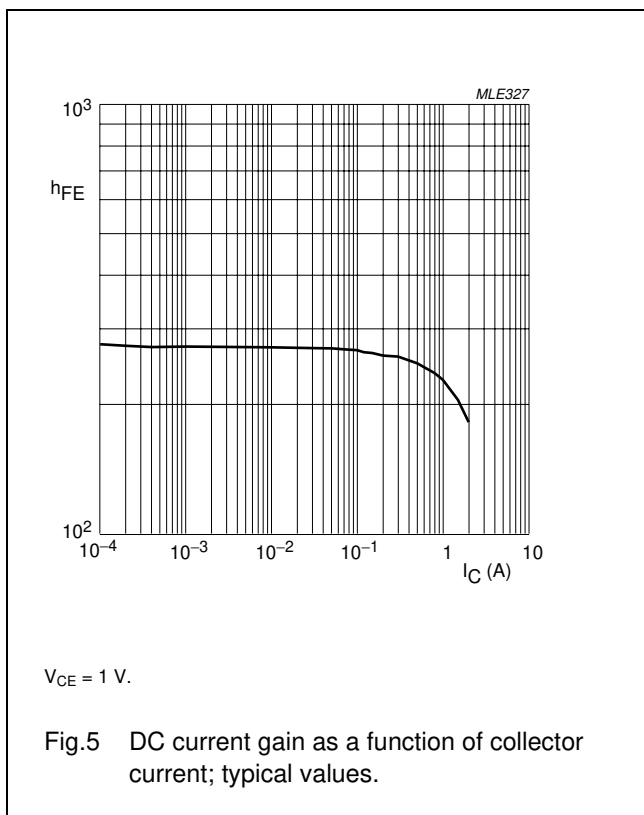
T_{amb} = 25 °C unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------------|--------------------------------------|---|------|------|------|------|
| I _{CBO} | collector-base cut-off current | V _{CB} = 25 V; I _E = 0 A | – | – | 100 | nA |
| | | V _{CB} = 25 V; I _E = 0 A; T _{amb} = 150 °C | – | – | 10 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = 5 V; I _C = 0 A | – | – | 100 | nA |
| h _{FE} | DC current gain | V _{CE} = 10 V; I _C = 5 mA | 50 | – | – | |
| | | V _{CE} = 1 V; I _C = 500 mA | 85 | – | 375 | |
| | | V _{CE} = 1 V; I _C = 1 mA | 60 | – | – | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = 1 A; I _B = 100 mA | – | – | 500 | mV |
| V _{BE} | base-emitter voltage | V _{CE} = 10 V; I _C = 5 mA | – | – | 700 | mV |
| | | V _{CE} = 1 V; I _C = 1 A | – | – | 1 | V |
| C _c | collector capacitance | V _{CB} = 10 V; I _E = i _e = 0 A; f = 1 MHz | – | 22 | – | pF |
| f _T | transition frequency | V _{CE} = 5 V; I _C = 50 mA; f = 100 MHz | 40 | 170 | – | MHz |



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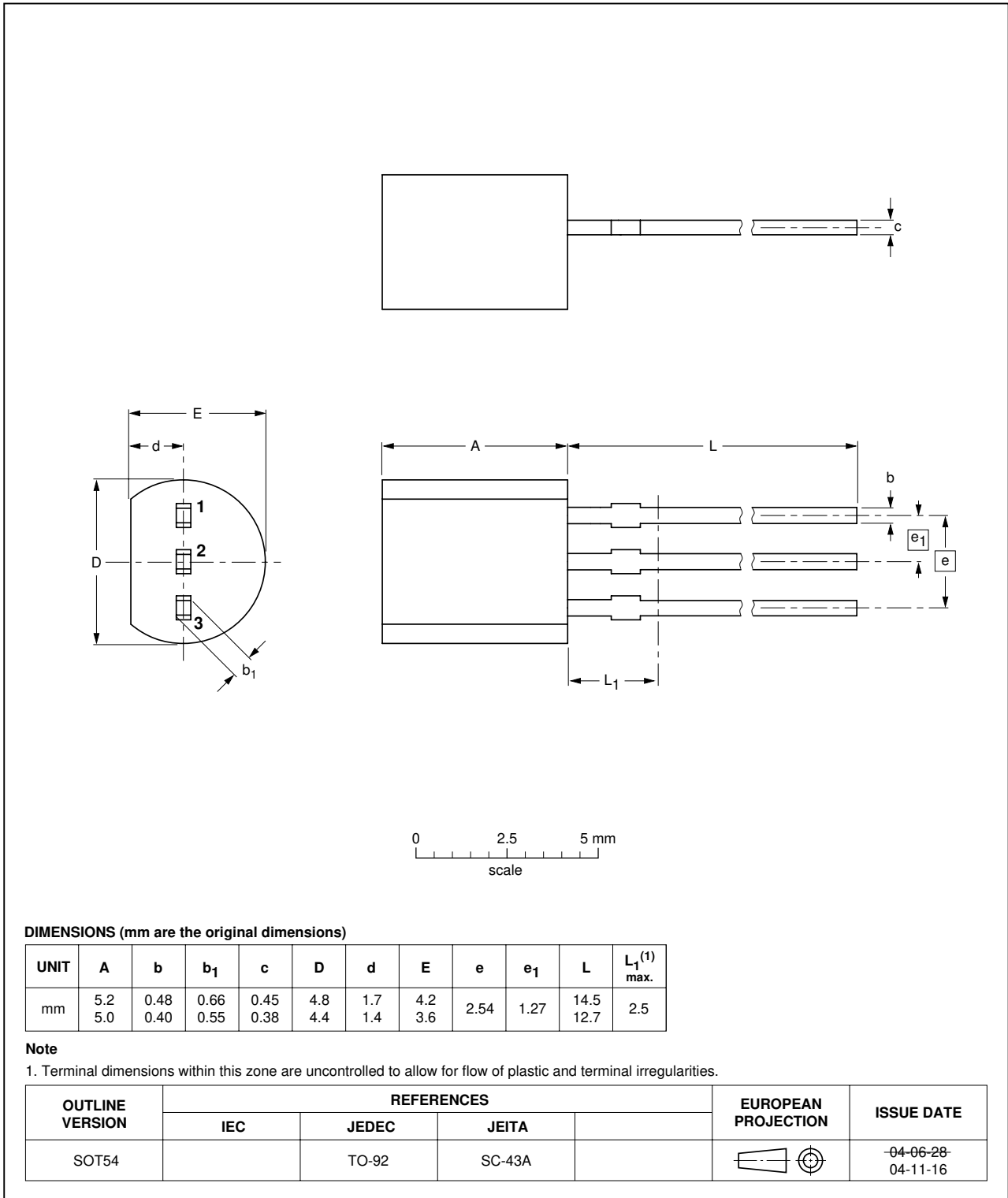
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PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



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DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

Notes

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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